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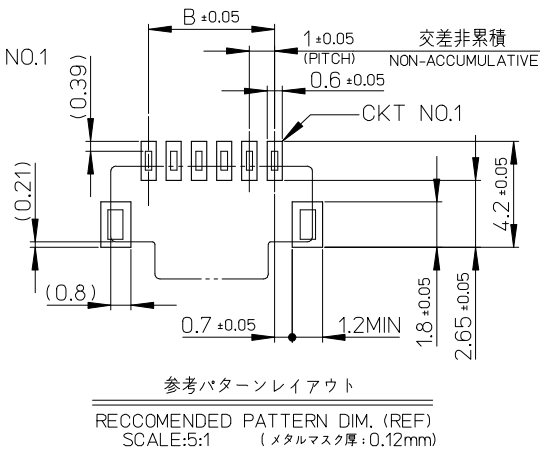
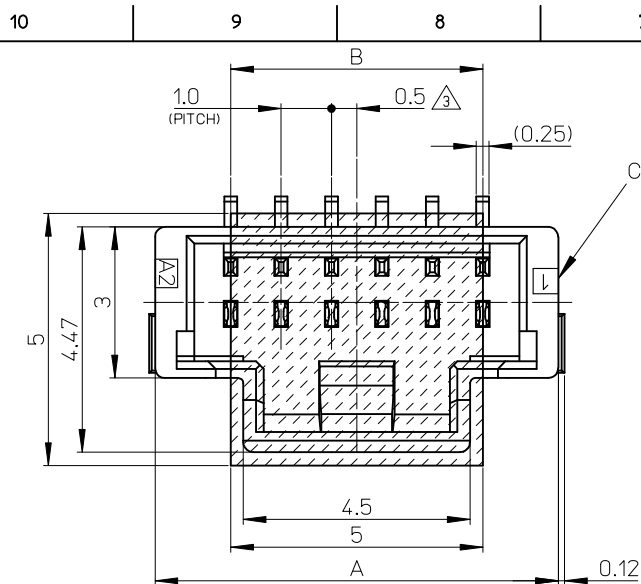
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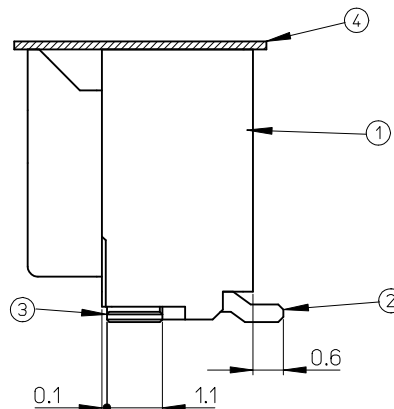
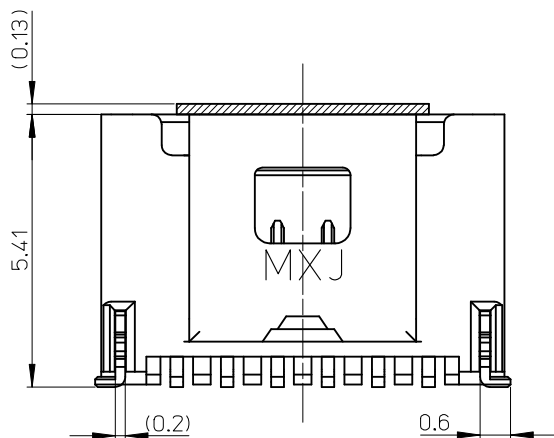
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番号 NO.	部品 PART	材質 MATERIAL
①	ウエハー WAFER	ポリアミド UL94V-0 色:ナチュラル POLYAMIDE UL94V-0, COLOR: NATURAL
②	ソルダーピン SOLDER PIN	りん青銅 PHOSPHOR BRONZE 部分金メッキ: 0.1 μm MIN. SEPARATED GOLD PLATING ニッケルメッキ(下地): 1.0 μm MIN. NICKEL(UNDER PLATING)
③	ネイル NAIL	りん青銅 PHOSPHOR BRONZE 錫メッキ: 1.0 μm MIN. TIN ニッケルメッキ(下地): 1.0 μm MIN. NICKEL(UNDER PLATING)
④	カバーテープ COVER TAPE	ポリイミドテープ POLYIMIDE TAPE



NOTES.

- 嵌合相手: 501330-****
MATE WITH: 501330-****
- ソルダーピン及びネイル平坦度は、0.1MAX.
SOLDER PIN AND NAIL COPLANARITY TO BE 0.1MAX.
- 極数=偶数に適用
APPLY FOR CKT SIZE=EVEN
- 2~5極は、SD-504449-001を参照下さい。
REFER TO SD-504449-001 ABOUT 2-5CKT.
- ELV及びRoHS適合品。
ELV AND RoHS COMPLIANT.

※対応可能な極数は、別途お問い合わせ下さい。

14.0	17.0	504449-1507	15
13.0	16.0	504449-1407	14
12.0	15.0	504449-1307	13
11.0	14.0	504449-1207	12
10.0	13.0	504449-1107	11
9.0	12.0	504449-1007	10
8.0	11.0	504449-0907	9
7.0	10.0	504449-0807	8
6.0	9.0	504449-0707	7
5.0	8.0	504449-0607	6
B	A	EMBOSSED PACKAGE オーダー番号 ORDER NO.	極数 CKT.

CONNECTOR SERIES No. 504449-***9

RELEASED EC NO: J2012-1436 2012/12/13 DRWN:KAWASHIO 2012/12/14 CHKD:KASAKAWA 2012/12/21 APPR:Y01TO	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION		
				MM ONLY		10:1	METRIC			
		10 UNDER	± 0.2	DRAWN BY	DATE	TITLE 1.0 WIRE TO BOARD CONN. WAFER ASS'Y (1-ROW S/T) 6-15CKT				
		10 OVER 30 UNDER	± 0.25	CHECKED BY	DATE					
		30 OVER	± 0.3	APPROVED BY	DATE	molex				
	ANGULAR ±3 °	MATERIAL NO.	DOCUMENT NO.							
REV	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE		SD-504449-002			1 OF 1		
			THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							

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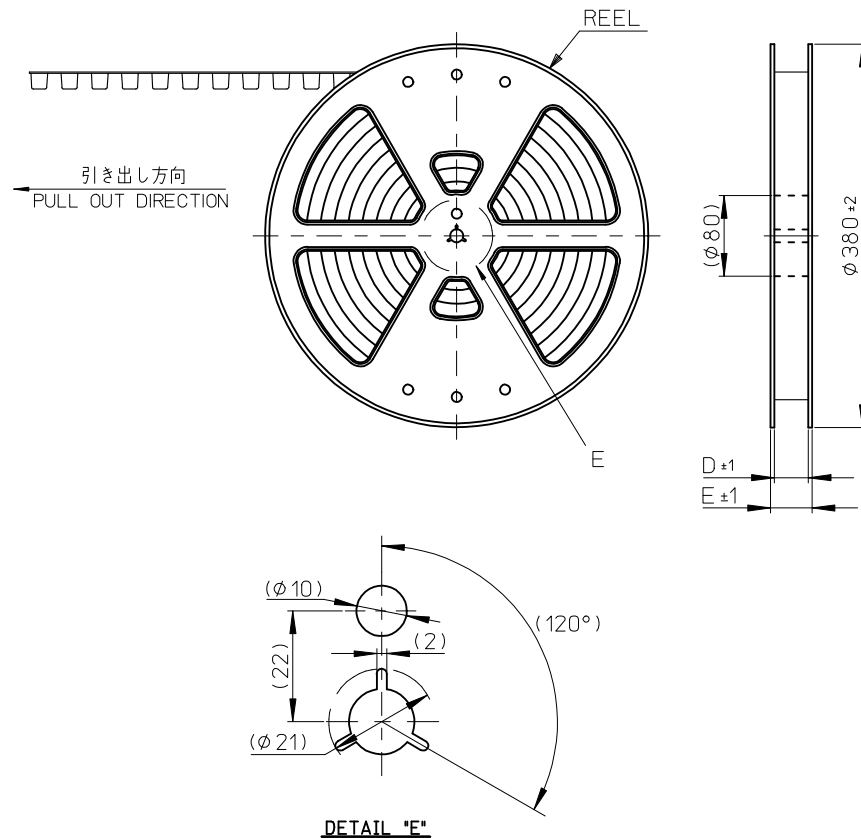
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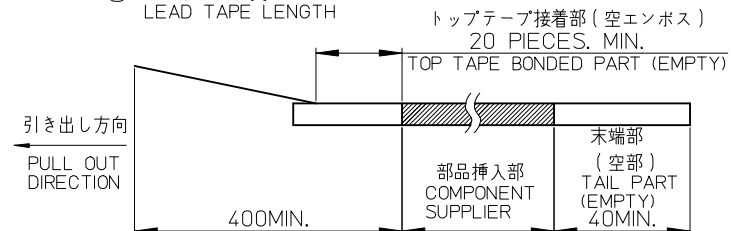
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NOTES.

- 製品詳細寸法については製品単体図面を参照ください。
ABOUT DETAILED DIMENSION, SEE PRODUCT DRAWING.
- 梱包数量: 1100個/リール
NUMBER OF CONNECTORS: 1100PIECES/REEL
- リードテープ長さ
LEAD TAPE LENGTH



- 材料
MATERIAL
キャリアテープ: ポリプロピレン
CARRIER TAPE: POLYPROPYLENE
トップテープ: PET、PE、REF
TOP TAPE
リール: ポリスチレン (リサイクル材を含む)
REEL: POLYSTYRENE (RECYCLE MATERIAL CONTAINED)
- ELV 及び RoHS適合品
ELV AND RoHS COMPLIANT.

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RELEASED EC NO: J2012-1436 2012/12/13 DRWN:KASHIO CHKD:KASAKAWA APPR:Y01TO 2012/12/14 2012/12/21	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION						
		10 UNDER	± 0.2	DRAWN BY KASHIO	DATE 2012/12/13	TITLE 1.0 WIRE TO BOARD CONN. WAFER ASS'Y (1-ROW S/T) EMBSTP PKG								
		10 OVER 30 UNDER	± 0.25	CHECKED BY	DATE									
		30 OVER	± 0.3	APPROVED BY Y01TO	DATE 2012/12/21	MATERIAL NO. SEE SHEET 2								
		ANGULAR ±1 °		DOCUMENT NO. SD-504449-004							SHEET NO. 1 OF 2			
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION											
	REV													

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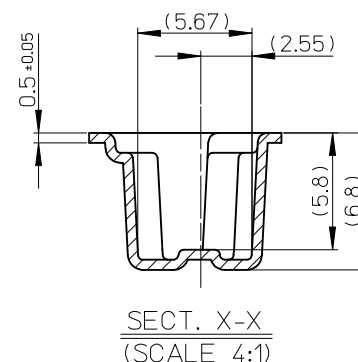
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SEE SHEET1 EC NO: J2012-1436 DRAWN: KWASHIO CHKD: KASAKAWA APPR: YOITO	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION			
		10 UNDER	± 0.2	DRAWN BY KWASHIO	DATE 2012/12/13	TITLE 1.0 WIRE TO BOARD CONN. WAFER ASS'Y (1-ROW S/T) EMBSTP PKG					
		10 OVER 30 UNDER	± 0.25	CHECKED BY							DATE
		30 OVER	± 0.3	APPROVED BY YOITO		DATE 2012/12/21	MOLEX INCORPORATED				
		ANGULAR ±1 °		MATERIAL NO.		DOCUMENT NO.				SHEET NO.	
	REV	0	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE		SD-504449-004				2 OF 2
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION											